# **TENTATIVE**

TOSHIBA Photocoupler GaAlAs Ired + Photo-IC

# TLP114A(IGM)

#### Transistor Invertor

Inverter For Air Conditioner

Line Receiver

Ipm Interfaces

The TOSHIBA mini flat coupler TLP114A is a small outline coupler, suitable for surface mount assembly.

TLP114A consists of a high output power GaAlAs light emitting diode, optically coupled to a high speed detector of one chip photo diode—transistor.

TLP114A(IGM) has no internal base connection, and a faraday shield integrated on the photodetector chip provides an effective common mode noise transient immunity.

TLP114A(IGM) guarantees minimum and maximum of propagation delay time, switching time dispersion, and high common mode transient immunity. There for TLP114A(IGM) is suitable for isolation interface between IPM(intelligent power module) and control IC circuits in motor control application.

- Isolation voltage: 3750V<sub>rms</sub>(min.)
- Common mode transient immunity

: ±10kV/μs(min.) @V<sub>CM</sub>=1500V

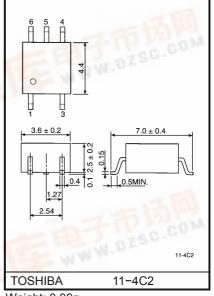
• Switching time: t<sub>pHL</sub>, t<sub>pLH</sub>=0.1µs(min.) =0.8µs(max.)

 $@I_{\text{F}}\text{=}10\text{mA},\,V_{\text{CC}}\text{=}15V,\\$ 

 $R_L$ =20kΩ, Ta=25°C

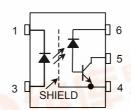
- Switching time dispersion: 0.7μs(max.) (|t<sub>pLH</sub>-t<sub>pHL</sub>|)
- TTL compatible
- UL recognized: UL1577, file no.E67349

## Unit in mm



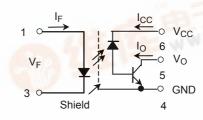
Weight: 0.09g

#### Pin Configuration(top view)



- 1 : Anode
- 3 : Cathode
- 4 : Emitter (GND)
- 5 : Collector (Output)
- 6 : V<sub>CC</sub>

#### **Schematic**





### **Maximum Ratings(Ta = 25°C)**

	Characteristic	Symbol	Rating	Unit	
	Forward current	(Note 1)	l <sub>F</sub>	20	mA
Ω	Pulse forward current	(Note 2)	I <sub>FP</sub>	40	mA
LED	Peak transient forward current	(Note 3)	I <sub>FPT</sub>	1	Α
	Reverse voltage		V <sub>R</sub>	5	٧
	Output current		Io	8	mA
Detector	Peak output current		I <sub>OP</sub>	16	mA
	Output voltage		Vo	-0.5~20	V
ă	Supply voltage		V <sub>CC</sub>	-0.5~30	٧
	Output power dissipation	(Note 4)	Po	100	mW
Оре	Operating temperature range			-55~100	°C
Stor	age temperature range	T <sub>stg</sub>	-55~125	°C	
Lea	d soldering temperature(10s)		T <sub>sol</sub>	260	°C
Isola	ation voltage(AC, 1min., R.H.≤60%, Ta=25°C)	(Note 5)	BVS	3750	Vrms

(Note 1): Derate 0.36mA above 70°C.

(Note 2): 50% duty cycle, 1ms pulse width.

Derate 0.72mA / °C above 70°C.

(Note 3): Pulse width PW  $\leq 1\mu s$ , 300pps.

(Note 4): Derate 1.8mW / °C above 70°C.

(Note 5): Device considerd a two terminal device: pins1, 3 shorted together and pins4, 5, 6 shorted together.

# **Electrical Characteristics(Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min.	Тур.	Max.	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> =16mA	1.22	1.42	1.72	V
LED	Forward voltage temperature coefficient	ΔV <sub>F</sub> / ΔTa	I <sub>F</sub> =16mA	_	-2	-	mV / °C
	Reverse current	$I_{R}$	V <sub>R</sub> =3V	_	_	10	μΑ
	Capacitance between terminal	СТ	V <sub>F</sub> =0, f=1MHz	_	30	-	pF
Detector	High level output current	I <sub>OH(1)</sub>	I <sub>F</sub> =0mA, V <sub>CC</sub> =V <sub>O</sub> =5.5V	_	3	500	nA
		I <sub>OH(2)</sub>	I <sub>F</sub> =0mA, V <sub>CC</sub> =30V V <sub>O</sub> =20V	-	_	5	μА
		Іон	I <sub>F</sub> =0mA, V <sub>CC</sub> =30V V <sub>O</sub> =20V, Ta=70°C	-	_	50	μΑ
	High level supply current	Іссн	I <sub>F</sub> =0mA, V <sub>CC</sub> =30V	_	0.01	1	μА
	Supply voltage	V <sub>CC</sub>	I <sub>CC</sub> =0.01mA	30	_	_	V
	Output voltage	Vo	I <sub>O</sub> =0.5mA	20	_		V

## **Coupled Electrical Characteristics(Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit	
Current transfer ratio	Io / IF	I <sub>F</sub> =10mA, V <sub>CC</sub> =4.5V V <sub>O</sub> =0.4V	25	35	75	%	
Current transfer ratio		I <sub>F</sub> =16mA, V <sub>CC</sub> =4.5V V <sub>O</sub> =0.4V, Ta=-25~100°C	15	_	-	70	
Low level output voltage	V <sub>OL</sub>	I <sub>F</sub> =10mA, V <sub>CC</sub> =4.5V I <sub>O</sub> =2.4mA		ı	0.4	V	

# Isolation Characteristics(Ta = 25°C)

Characteristic	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Capacitance input to output	Cs	V=0, f=1MHz (Note 5)	_	8.0	-	pF
Isolation resistance	R <sub>S</sub>	R.H.≤60%, V <sub>S</sub> =500V (Note 5)	5×10 <sup>10</sup>	10 <sup>14</sup>		Ω
		AC, 1 minute	3750	_	_	Vrms
Isolation voltage	$BV_S$	AC, 1 second, in oil	_	10000	-	VIIIIS
		DC, 1 minute, in oil	_	10000	_	Vdc

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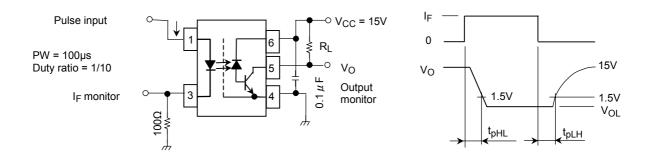
# Switching Characteristics(Ta = 25°C, V<sub>CC</sub> = 15V)

Characteristic		Symbol	Test Cir– Cuit	Test Condition	Min.	Тур.	Max.	Unit
Propagation delay time		t <sub>pHL</sub>		$I_F=0 \rightarrow 10 \text{mA}, R_L=20 \text{k}\Omega$	0.1	0.45	0.8	
(H→ L)  Propagation delay time		t <sub>pLH</sub>		$I_F$ =0→ 10mA, $R_L$ =20kΩ $T$ a=0~85°C	0.1	0.45	0.9	μs
(L→ H)			1	$I_F$ =0 $\rightarrow$ 10mA, $R_L$ =20k $\Omega$ Ta= $-25$ ~100°C	0.1	0.45	1.0	
	sion between on    t <sub>pLH</sub> -t <sub>pHL</sub>	t <sub>pLH</sub> -t <sub>pHL</sub>		I <sub>F</sub> =10 $\rightarrow$ 0mA, R <sub>L</sub> =20kΩ	_	0.15	0.7	μs
Switching time dispersion between on				$I_F$ =10 $\rightarrow$ 0mA, $R_L$ =20k $\Omega$ Ta=0~85°C	_	0.25	0.8	
and off				$I_F$ =10 $\rightarrow$ 0mA, R <sub>L</sub> =20kΩ Ta=–25~100°C	_	0.25	0.9	
Common mode transient immunity at logic high output	(Note 6)	CM <sub>H</sub>	2	$I_F$ =0mA $V_{CM}$ =1500 $V_{p-p}$ $R_L$ =20k $\Omega$	10000	15000	_	V / µs
Common mode transient immunity at logic low output	(Note 6)	CML	2	I <sub>F</sub> =10mA V <sub>CM</sub> =1500V <sub>p-p</sub> R <sub>L</sub> =20kΩ	-10000	-15000	_	V / µs

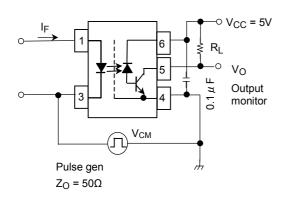
(Note 6): CM<sub>L</sub> is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state ( $V_O$ <1V). CM<sub>H</sub> is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state ( $V_O$ <4V).

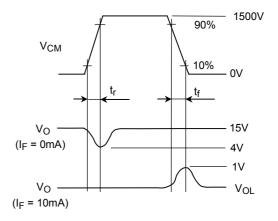
(Note 7): Maximum electrostatic discharge voltage for any pins: 100V (C=200pF, R=0).

#### **Test Circuit 1: Switching Time Test Circuit**



# **Test Circuit 2: Common Mode Noise Immunity Test Circuit**





$$CM_{H} = \frac{1200(V)}{t_{f}(\mu s)}, CM_{L} = \frac{1200(V)}{t_{f}(\mu s)}$$

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